

STPS20120D

POWER SCHOTTKY RECTIFIER

Table 1: Main Product Characteristics

I _{F(AV)}	20 A
V _{RRM}	120 V
T _j (max)	175°C
V _F (typ)	0.54 V

FEATURES AND BENEFITS

- High junction temperature capability
- Avalanche rated
- Low leakage current
- Good trade-off between leakage current and forward voltage drop

DESCRIPTION

Single Schottky rectifier suited for high frequency Switch Mode Power Supply.

Packaged in TO-220AC, this device is intended to be used in notebook & LCD adaptors, desktop SMPS, providing in these applications a margin between the remaining voltages applied on the diode and the voltage capability of the diode.

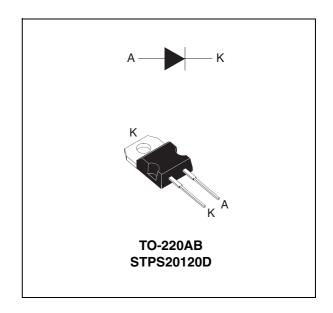


Table 2: Order Code

Part Number	Marking
STPS20120D	STPS20120D

Table 3: Absolute Ratings (limiting values)

Symbol	Paramete	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	120	V	
I _{F(RMS)}	RMS forward voltage	30	Α	
I _{F(AV)}	Average forward current $\delta = 0.5$ $T_c = 130$ °C		20	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10$ ms sinusoidal		200	Α
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \mu s$ $T_j = 25$ °C		8600	W
T _{stg}	Storage temperature range	-65 to + 175	°C	
T _j	Maximum operating junction temperatu	175	°C	

^{*:} $\frac{dPtot}{dTj}$ > $\frac{1}{Rth(j-a)}$ thermal runaway condition for a diode on its own heatsink

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Table 4: Thermal Parameters

Symbo	Parameter Parameter	Value	Unit
R _{th(j-c}	Junction to case	2.2	°C/W

Table 5: Static Electrical Characteristics

Symbol	Parameter	Tests conditions		Min.	Тур	Max.	Unit
I _R * Reverse leakage	Reverse leakage current	$T_j = 25^{\circ}C$	$V_R = V_{RRM}$			20	μΑ
	Theverse leakage current	T _j = 125°C			3	10	mA
		T _j = 25°C	I _F = 5A			0.7	
V _F ** Forward voltage drop		T _j = 125°C			0.54	0.58	
	Forward voltage drop	$T_j = 25^{\circ}C$	I _F = 10A			0.8	V
	Torward voltage drop	T _j = 125°C			0.62	0.66	
		T _j = 25°C	I _F = 20A			0.93	
		T _j = 125°C	.F =3/1		0.72	0.76	

To evaluate the conduction losses use the following equation: $P = 0.56 \times I_{F(AV)} + 0.010 I_{F}^{2}$ (RMS)

Figure 1: Average forward power dissipation versus average forward current

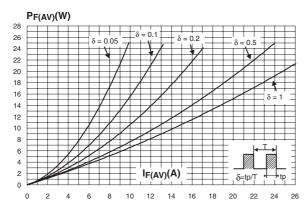


Figure 3: Normalized avalanche power derating versus pulse duration

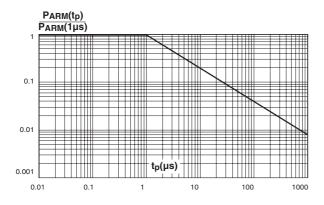


Figure 5: Non repetitive surge peak forward current versus overload duration (maximum values)

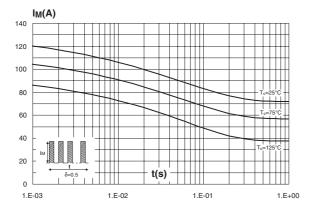


Figure 2: Average forward current versus ambient temperature ($\delta = 0.5$)

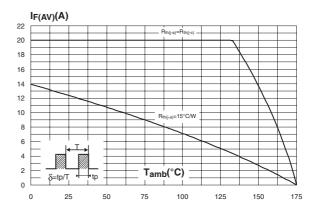


Figure 4: Normalized avalanche power derating versus junction temperature

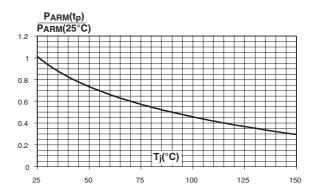
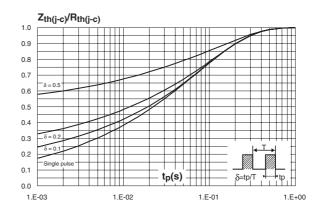


Figure 6: Relative variation of thermal impedance junction to ambient versus pulse duration



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Figure 7: Reverse leakage current versus reverse voltage applied (typical values)

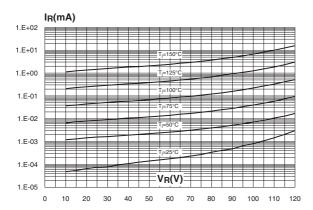


Figure 9: Forward voltage drop versus forward current

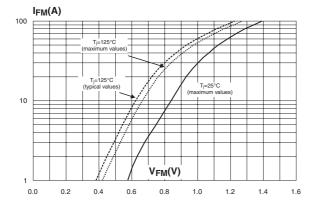
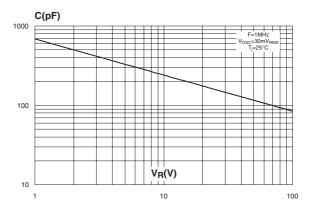


Figure 8: Junction capacitance versus reverse voltage applied (typical values)



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Figure 10: TO-220AC Package Mechanical Data

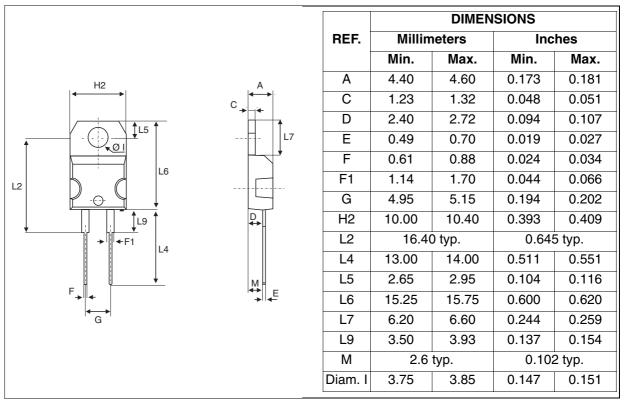


Table 6: Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS20120D	STPS20120D	TO-220AC	1.90 g	50	Tube

■ Epoxy meets UL94, V0

■ Cooling method: by conduction (C)

■ Recommended torque value: 0.55 m.N.

■ Maximum torque value: 0.70 m.N.

Table 7: Revision History

Date	Revision	Description of Changes
18-Feb-2005	1	First issue.

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